



# Product Change Notification

**Change Notification #:** 117563 - 00  
**Change Title:** Intel® Data Center Blocks for Cloud,  
MCB2224BPHY1R, MCB2224BPAF3R,  
MCB2312WFHY2R, MCB2208WFAF4R,  
MCB2208WFAF5R, MCB2208WFAF6R,  
MCB2208WFAF7R, MCB2208WFAF8R,  
MCB2208WFAF9R, MCB2208WFAF10R,  
PCN 117563-00, Product Design, Order Code,  
Replacing select Intel CPUs  
**Date of Publication:** April 20, 2020

## Key Characteristics of the Change:

Product Design, Order Code

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	May 5, 2020
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel Corporation is replacing Intel® Xeon™ Silver 4215, Intel® Xeon™ Gold 5218 and Intel® Xeon™ Gold 6230 processors in Intel® Data Center Blocks for Cloud as listed in the "Products Affected/Intel Ordering Codes" table below with Intel® Xeon™ Silver 4210R, Intel® Xeon™ Silver 4216 and Intel® Xeon™ Gold 5218R processors. As the result the affected Intel® Data Center Blocks for Cloud models will be discontinued and replaced with the updated models.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes but encourages customers to understand the changes and determine the impact on their applications.

The date of "Customer Must be Ready to Receive Post-Conversion Material" is the projected date customers must be prepared to start receiving the Post-Converted Material. After this date, the Pre-Conversion SKUs will be discontinued and no longer guaranteed. They may be available only on a first come first serve basis, while supply lasts.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Product Name	Pre Change Product Code	Pre Change MM#	Old CPU	Post Change Product Code	Post Change MM#	New CPU
Intel® Server System MCB2208WFAF10R	MCB2208WFAF10R	999GKP	Intel® Xeon™ Gold 6230	MCB2208WFAF10R	99A3CH	Intel® Xeon™ Gold 5218R
Intel® Server System MCB2208WFAF9R	MCB2208WFAF9R	999GKR	Intel® Xeon™ Gold 6230	MCB2208WFAF9R	99A3JH	Intel® Xeon™ Gold 5218R
Intel® Server System MCB2208WFAF8R	MCB2208WFAF8R	999GKT	Intel® Xeon™ Gold 6230	MCB2208WFAF8R	99A3JJ	Intel® Xeon™ Gold 5218R
Intel® Server System MCB2208WFAF7R	MCB2208WFAF7R	999GKV	Intel® Xeon™ Gold 5218	MCB2208WFAF7R	99A3JK	Intel® Xeon™ Gold 5218R
Intel® Server System MCB2208WFAF6R	MCB2208WFAF6R	999GKW	Intel® Xeon™ Gold 5218	MCB2208WFAF6R	99A3JL	Intel® Xeon™ Silver 4216
Intel® Server System MCB2208WFAF5R	MCB2208WFAF5R	999GKX	Intel® Xeon™ Gold 5218	MCB2208WFAF5R	99A3R9	Intel® Xeon™ Silver 4216
Intel® Server System MCB2208WFAF4R	MCB2208WFAF4R	999GKZ	Intel® Xeon™ Gold 5218	MCB2208WFAF4R	99A3JN	Intel® Xeon™ Silver 4216
Intel® Server System MCB2312WFHY2R	MCB2312WFHY2R	999JKT	Intel® Xeon™ Gold 5218	MCB2312WFHY2R	99A3JT	Intel® Xeon™ Silver 4210R
Intel® Server System MCB2224BPAF3R	MCB2224BPAF3R	999LDM	Intel® Xeon™ Gold 5218	MCB2224BPAF3R	99A3JR	Intel® Xeon™ Gold 5218R
Intel® Server System MCB2224BPHY1R	MCB2224BPHY1R	999LDP	Intel® Xeon™ Silver 4215	MCB2224BPHY1R	99A3JV	Intel® Xeon™ Silver 4210R

## PCN Revision History:

**Date of Revision:**

April 20, 2020

**Revision Number:**

00

**Reason:**

Originally Published PCN



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## 117563 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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